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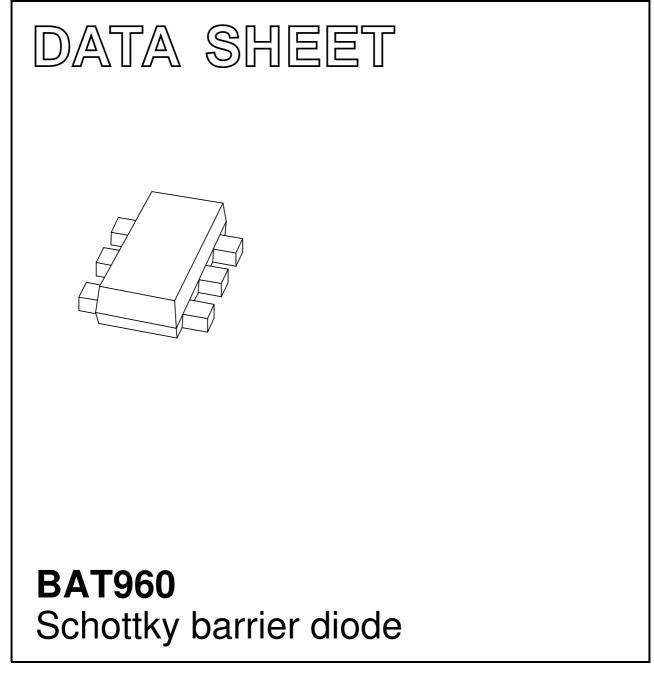
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2002 Jun 24 2003 May 01



Product data sheet

Schottky barrier diode

BAT960

FEATURES

- High current capability
- Very low forward voltage
- Ultra small plastic SMD package
- Flat leads: excellent coplanarity and improved thermal behaviour.

APPLICATIONS

- Ultra high-speed switching
- rectification
- DC/DC conversion
- Switch mode power supply
- Inverse polarity protection.

GENERAL DESCRIPTION

Planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT666 ultra small SMD plastic package.

Ρ	IN	IN	IN	G

PIN	DESCRIPTION	
1	cathode	
2	cathode	
3	anode	
4	anode	
5	cathode	
6	cathode	

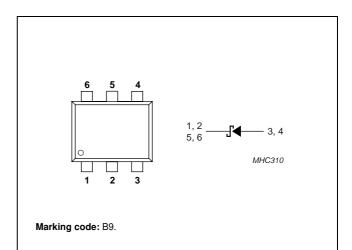


Fig.1 Simplified outline (SOT666) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		-	23	V
I _F	continuous forward current		-	1	A
I _{FSM}	non-repetitive peak forward current	t = 8.3 ms half sinewave; JEDEC method; note 1	-	8	A
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	125	°C
T _{amb}	operating ambient temperature		-65	+125	°C

Note

1. Only valid, if pins 3 and 4 are connected in parallel.

Schottky barrier diode

BAT960

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	405	K/W
		note 2	215	K/W

Notes

- 1. Refer to SOT666 standard mounting conditions.
- 2. Mounted on printed circuit-board, 1 cm² copper area.

Soldering

The only recommended soldering method is reflow soldering.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	continuous forward voltage	I _F = 10 mA	240	270	mV
		I _F = 100 mA	300	350	mV
		$I_F = 1000 \text{ mA}; \text{ note } 1; \text{ see Fig.2}$	480	550	mV
I _R	reverse current	V _R = 5 V; note 2	5	10	μA
		V _R = 8 V; note 2	7	20	μ A
		$V_R = 15 V$; note 2; see Fig.3	10	50	μA
C _d	diode capacitance	$V_R = 5 V$; f = 1 MHz; see Fig.4	19	25	pF

Notes

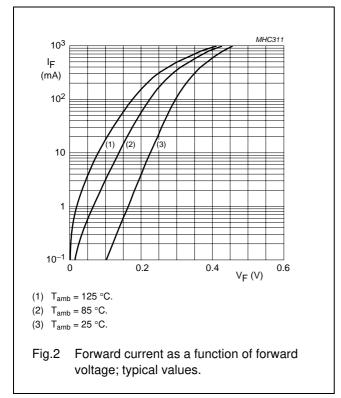
1. Only valid, if pins 1, 2, 5 and 6 are soldered on a 1 cm^2 copper solder land.

2. Pulse test: $t_p = 300 \ \mu s$; $\delta = 0.02$.

Schottky barrier diode

BAT960





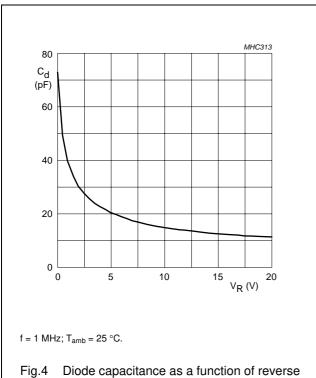
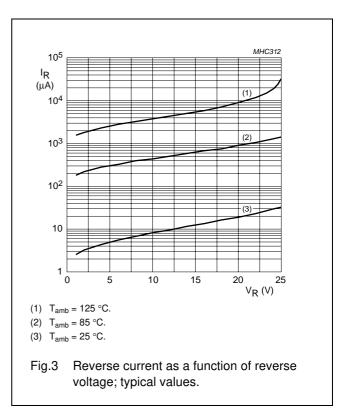


Fig.4 Diode capacitance as a function of reverse voltage; typical values.

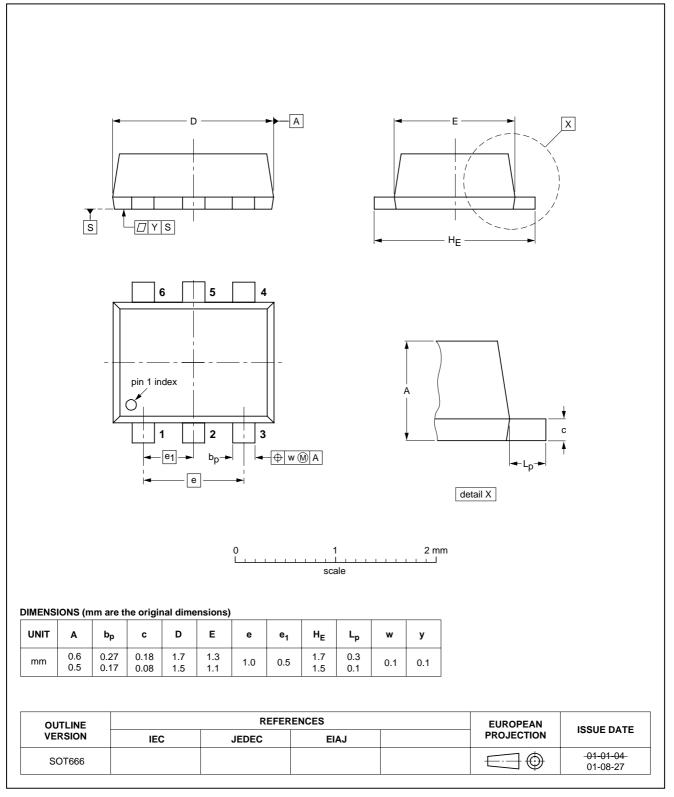


BAT960

Schottky barrier diode

PACKAGE OUTLINE





SOT666

Schottky barrier diode

BAT960

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

DATA SHEET STATUS

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
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NXP Semiconductors

Customer notification

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Contact information

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